

### **Product Carbon Footprint**



IBM® is committed to environmental leadership in all its business activities, from operations to the design of its products and use of its technology. To help our clients better understand the environmental impacts associated with IBM products, we report the product carbon footprint for representative products.

#### IBM z16<sup>™</sup> rack mount configuration

CPC drawer	
Module DCM, all cores	2
PCIe Fan Out Gen 4	2
Integrated Coupling Adapter SR	1
6U Shipping POD and Pallet	1
PCIe+ I/O drawer	
FICON Express32S LX	8
OSA-Express7S 10 GbE LR	6
Coupling Express2 LR	1
Crypto Express8S (2 HSM)	1
PCIe Interconnect Gen4	2
9U Shipping Pod	1
Support Element	
1U Server Support Element	1
6U Shipping Pod	1
Ethernet Switch	
24-port Ethernet Switch	1

 Table 1: Typical product configuration



**CPC Drawer Product Carbon Footprint** 



IBM<sup>®</sup> is committed to environmental leadership in all its business activities, from operations to the design of its products and use of its technology. To help our clients better understand the environmental impacts associated with IBM products, we report the product carbon footprint for representative products.

IBM z16 <sup>™</sup> rack mount CPC drawer configuration		
Module DCM, all cores	2	
PCIe Fan Out Gen 4	2	
Integrated Coupling Adapter SR	1	
6U Shipping POD and Pallet	1	

 Table 2: Typical CPC drawer product configuration

## **39,000** kg CO2e<sup>1</sup>

This number is the estimated mean GHG emissions in carbon dioxide equivalent associated with the manufacturing, assembly, electricity consumption<sup>2</sup>, transportation and end-of-life handling of the IBM z16<sup>™</sup> rack mount CPC drawer over 5 years using hypothetical average GHG emissions factors for the European Union.

This PCF estimate was produced using the Product Attributes to Impact Algorithm (PAIA) model, developed by the Massachusetts Institute of Technology's Materials Systems Laboratory and partners, Version 1.3.2, January 25, 2023, copyright by the ICT Benchmarking collaboration including the Massachusetts Institute of Technology's Materials Systems Laboratory and partners.

All estimates of carbon footprint are uncertain. For this product, the estimate has a mean of  $39,000 \text{ kg CO}_{2e}$ and a standard deviation of  $23,000 \text{ kg CO}_{2e}$  ( $39,000 \pm 23,000 \text{ kg CO}_{2e}$ ) over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. IBM also reports the  $95^{\text{th}}$  percentile of the carbon footprint estimate, which is  $109,000 \text{ kg CO}_{2e}$ over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. The  $95^{\text{th}}$ percentile means that 5% of the time the carbon footprint will exceed the value provided.

#### Impact by phases of the product's lifecycle

The PCF for server equipment is largely driven by the use phase which is highly variable based on the electricity generation source used to power the product, the expected use life of the product, and the power profile. This PCF was generated using a distribution of emissions factors across the European Union. The analysis for this product shows that 82.7% of its carbon footprint occurs in the use phase. IBM focuses on improving our product energy efficiency and on providing mechanisms for our clients to measure the actual energy consumption of the product. Figure 1 shows the estimated mean contribution for the individual phases of the product's lifecycle over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. Figure 2 shows the uncertainty in the product's carbon footprint. The blue bar representing the mean and one standard deviation and the error bars representing the 5<sup>th</sup> and 95<sup>th</sup> percentile of the carbon footprint estimate.



Figure 1: Carbon footprint impact by phase for the IBM z16<sup>™</sup> rack mount CPC drawer typical product configuration listed in Table 2 using the PAIA model; 82.7% occurs in the use phase and the remaining 17.3% is broken out.



**Figure 2:** Uncertainty in the PCF estimate for the IBM  $z16^{m}$  rack mount CPC drawer typical product configuration listed in Table 2; the estimate has a total mean of 39,000 ± 23,000 kg CO<sub>2</sub>e over a use period of 5 years.



### PCIe+ I/O Drawer Product Carbon Footprint



IBM<sup>®</sup> is committed to environmental leadership in all its business activities, from operations to the design of its products and use of its technology. To help our clients better understand the environmental impacts associated with IBM products, we report the product carbon footprint for representative products.

IBM z16™ rack mount PCIe+ I/O configuration	) drawer
FICON Express32S LX	8
OSA-Express7S 10 GbE LR	6
Coupling Express2 LR	1
Crypto Express8S (2 HSM)	1
PCIe Interconnect Gen4	2
9U Shipping Pod	1

 Table 3: Typical PCIe+ I/O drawer product configuration

## **19,000** kg CO2e<sup>1</sup>

This number is the estimated mean GHG emissions in carbon dioxide equivalent associated with the manufacturing, assembly, electricity consumption<sup>2</sup>, transportation and end-of-life handling of the IBM z16<sup>™</sup> rack mount PCIe+ I/O drawer over 5 years using hypothetical average GHG emissions factors for the European Union.

This PCF estimate was produced using the Product Attributes to Impact Algorithm (PAIA) model, developed by the Massachusetts Institute of Technology's Materials Systems Laboratory and partners, Version 1.3.2, January 25, 2023, copyright by the ICT Benchmarking collaboration including the Massachusetts Institute of Technology's Materials Systems Laboratory and partners.

All estimates of carbon footprint are uncertain. For this product, the estimate has a mean of 19,000 kg CO<sub>2</sub>e and a standard deviation of 20,000 kg CO<sub>2</sub>e (19,000 ± 20,000 kg CO<sub>2</sub>e) over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. IBM also reports the 95<sup>th</sup> percentile of the carbon footprint estimate, which is 130,000 kg CO<sub>2</sub>e over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. The 95<sup>th</sup> percentile means that 5% of the time the carbon footprint will exceed the value provided.

#### Impact by phases of the product's lifecycle

The PCF for server equipment is largely driven by the use phase which is highly variable based on the electricity generation source used to power the product, the expected use life of the product, and the power profile. This PCF was generated using a distribution of emissions factors across the European Union. The analysis for this product shows that 76.1% of its carbon footprint occurs in the use phase. IBM focuses on improving our product energy efficiency and on providing mechanisms for our clients to measure the actual energy consumption of the product. Figure 3 shows the estimated mean contribution for the individual phases of the product's lifecycle over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. Figure 4 shows the uncertainty in the product's carbon footprint. The blue bar representing the mean and one standard deviation and the error bars representing the 5<sup>th</sup> and 95<sup>th</sup> percentile of the carbon footprint estimate.



Figure 3: Carbon footprint impact by phase for the IBM z16<sup>™</sup> rack mount PCIe+ I/O drawer typical product configuration listed in Table 3 using the PAIA model; 76.1% occurs in the use phase and the remaining 23.9% is broken out.



**Figure 4:** Uncertainty in the PCF estimate for the IBM  $z16^{m}$  rack mount PCIe+ I/O drawer typical product configuration listed in Table 3; the estimate has a total mean of 19,000  $\pm$  20,000 kg CO<sub>2</sub>e over a use period of 5 years.



## Support Element Product Carbon Footprint



IBM<sup>®</sup> is committed to environmental leadership in all its business activities, from operations to the design of its products and use of its technology. To help our clients better understand the environmental impacts associated with IBM products, we report the product carbon footprint for representative products.

IBM z16™ rack mount Support Element configuration	
1U Server Support Element	1
6U Shipping Pod	1

 Table 4: Typical Support Element product configuration

# **4,000** kg CO2e<sup>1</sup>

This number is the estimated mean GHG emissions in carbon dioxide equivalent associated with the manufacturing, assembly, electricity consumption<sup>2</sup>, transportation and end-of-life handling of the IBM z16<sup>™</sup> rack mount Support Element over 5 years using hypothetical average GHG emissions factors for the European Union.

This PCF estimate was produced using the Product Attributes to Impact Algorithm (PAIA) model, developed by the Massachusetts Institute of Technology's Materials Systems Laboratory and partners, Version 1.3.2, January 25, 2023, copyright by the ICT Benchmarking collaboration including the Massachusetts Institute of Technology's Materials Systems Laboratory and partners.

All estimates of carbon footprint are uncertain. For this product, the estimate has a mean of 4,000 kg CO<sub>2</sub>e and a standard deviation of 2,000 kg CO<sub>2</sub>e (4,000  $\pm$  2,000 kg CO<sub>2</sub>e) over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. IBM also reports the 95<sup>th</sup> percentile of the carbon footprint estimate, which is 11,000 kg CO<sub>2</sub>e over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. The 95<sup>th</sup> percentile means that 5% of the time the carbon footprint will exceed the value provided.

#### Impact by phases of the product's lifecycle

The PCF for server equipment is largely driven by the use phase which is highly variable based on the electricity generation source used to power the product, the expected use life of the product, and the power profile. This PCF was generated using a distribution of emissions factors across the European Union. The analysis for this product shows that 65.2% of its carbon footprint occurs in the use phase. IBM focuses on improving our product energy efficiency and on providing mechanisms for our clients to measure the actual energy consumption of the product. Figure 5 shows the estimated mean contribution for the individual phases of the product's lifecycle over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. Figure 6 shows the uncertainty in the product's carbon footprint. The blue bar representing the mean and one standard deviation and the error bars representing the 5<sup>th</sup> and 95<sup>th</sup> percentile of the carbon footprint estimate.



Figure 5: Carbon footprint impact by phase for the IBM z16<sup>™</sup> rack mount Support Element typical product configuration listed in Table 4 using the PAIA model; 65.2% occurs in the use phase and the remaining 34.8% is broken out.



**Figure 6:** Uncertainty in the PCF estimate for the IBM  $z16^{14}$  rack mount Support Element typical product configuration listed in Table 4; the estimate has a total mean of 4,000  $\pm$  2,000 kg CO<sub>2</sub>e over a use period of 5 years.



### 24-port Ethernet Switch Product Carbon Footprint



IBM<sup>®</sup> is committed to environmental leadership in all its business activities, from operations to the design of its products and use of its technology. To help our clients better understand the environmental impacts associated with IBM products, we report the product carbon footprint for representative products.

**Table 5:** Typical 24-port Ethernet Switch product configuration

# **3,000** kg CO2e<sup>1</sup>

This number is the estimated mean GHG emissions in carbon dioxide equivalent associated with the manufacturing, assembly, electricity consumption<sup>2</sup>, transportation and end-of-life handling of the IBM z16<sup>™</sup> rack mount 24-port Ethernet Switch over 5 years using hypothetical average GHG emissions factors for the European Union.

This PCF estimate was produced using the Product Attributes to Impact Algorithm (PAIA) model, developed by the Massachusetts Institute of Technology's Materials Systems Laboratory and partners, Version 1.3.2, January 11, 2023, copyright by the ICT Benchmarking collaboration including the Massachusetts Institute of Technology's Materials Systems Laboratory and partners.

All estimates of carbon footprint are uncertain. For this product, the estimate has a mean of 3,000 kg CO<sub>2</sub>e and a standard deviation of 2,000 kg CO<sub>2</sub>e (3,000  $\pm$  2,000 kg CO<sub>2</sub>e) over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. IBM also reports the 95<sup>th</sup> percentile of the carbon footprint estimate, which is 7,000 kg CO<sub>2</sub>e over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. The 95<sup>th</sup> percentile means that 5% of the time the carbon footprint will exceed the value provided.

#### Impact by phases of the product's lifecycle

The PCF for server equipment is largely driven by the use phase which is highly variable based on the electricity generation source used to power the product, the expected use life of the product, and the power profile. This PCF was generated using a distribution of emissions factors across the European Union. The analysis for this product shows that 93.9% of its carbon footprint occurs in the use phase. IBM focuses on improving our product energy efficiency and on providing mechanisms for our clients to measure the actual energy consumption of the product. Figure 7 shows the estimated mean contribution for the individual phases of the product's lifecycle over a use period of 5 years using hypothetical average GHG emissions factors for the European Union. Figure 8 shows the uncertainty in the product's carbon footprint. The blue bar representing the mean and one standard deviation and the error bars representing the 5<sup>th</sup> and 95<sup>th</sup> percentile of the carbon footprint estimate.



Figure 7: Carbon footprint impact by phase for the IBM z16<sup>™</sup> rack mount 24-port Ethernet Switch product configuration listed in Table 5 using the PAIA model; 93.9% occurs in the use phase and the remaining 6.1% is broken out.



**Figure 8:** Uncertainty in the PCF estimate for the IBM  $z16^{m}$  rack mount 24-port Ethernet Switch typical product configuration listed in Table 5; the estimate has a total mean of 3,000  $\pm$  2,000 kg CO<sub>2</sub>e over a use period of 5 years.

#### PAIA input assumptions

The PCF assumes a typical configuration of the product as described in Table 1. The numbers for your specific configuration might be different. The data used in the PAIA server tool is provided in Table 6 for the IBM z16<sup>™</sup> rack mount CPC drawer.

PAIA input information <sup>3</sup>	
Server type	Rack
Server quantity	1
Number of PSU	2
Number of fans	5
Server weight	83.0 kg
Rack weight	N/A
Packaging weight	47.6 kg
Motherboard	
PWB area	2374.6 cm <sup>2</sup>
CPU quantity	2
CPU package area	56.4 cm <sup>2</sup>
DRAM total capacity	1.54 TB
Chipset & other ICs package area	Default
Chipset & other ICs quantity	Default
Storage	
SSD quantity	N/A
SSD PWB area	N/A
SSD IC area total	N/A
SSD IC quantity	N/A
Daughterboards	
Sub card total PWB area	2193.3 cm <sup>2</sup>
Sub card main chip package area	177.3 cm <sup>2</sup>
Sub card chip count	61
PSU	
PSU weight	1.13 kg
PSU dimensions	19.2 x 10.0 cm
Optical disk drives	
ODD quantity	N/A
Use <sup>4</sup>	
Product lifetime	5 years
Yearly energy consumption	12956 kWh
Location	
Assembly location	United States
Use location	Europe
Transportation	
To country of use by air	6120 km
Within country of use by truck	300 km
End of life	
Fraction recycled	0.97
Fraction shredded recycling	0.00

**Table 6:** PAIA input information for the IBM z16  $^{\rm m}$  rack mount CPC drawer

The data used in the PAIA server tool is provided in Table 7 for the IBM z16<sup>™</sup> rack mount PCIe+ I/O drawer.

PAIA input information <sup>3</sup>	
Server type	Rack
Server quantity	1
Number of PSU	2
Number of fans	6
Server weight	90.7 kg
Rack weight	N/A
Packaging weight	32.2 kg
Motherboard	
PWB area	2164.0 cm <sup>2</sup>
CPU quantity	0
CPU package area	N/A
DRAM total capacity	N/A
Chipset & other ICs package area	Default
Chipset & other ICs quantity	Default
Storage	
SSD quantity	N/A
SSD PWB area	N/A
SSD IC area total	N/A
SSD IC quantity	N/A
Daughterboards	
Sub card total PWB area	19515.9 cm <sup>2</sup>
Sub card main chip package area	520.9 cm <sup>2</sup>
Sub card chip count	110
PSU	
PSU weight	1.04 kg
PSU dimensions	20.0 x 10.0 cm
Optical disk drives	
ODD quantity	N/A
Use <sup>4</sup>	
Product lifetime	5 years
Yearly energy consumption	5676 kWh
Location	
Assembly location	United States
Use location	Europe
Transportation	
To country of use by air	6120 km
Within country of use by truck	300 km
End of life	
Fraction recycled	0.97
Fraction shredded recycling	0.00

**Table 7:** PAIA input information for the IBM  $z16^{\text{TM}}$  rack mount PCIe+ I/O drawer

The data used in the PAIA server tool is provided in Table 8 for the IBM z16<sup>™</sup> rack mount Support Element.

PAIA input information <sup>5</sup>	
Server type	Rack
Server quantity	1
Number of PSU	2
Number of fans	5
Server weight	16.0 kg
Rack weight	N/A
Packaging weight	27.2 kg
Motherboard	
PWB area	791.1 cm <sup>2</sup>
CPU quantity	1
CPU package area	14.1 cm <sup>2</sup>
DRAM total capacity	0.032 TB
Chipset & other ICs package area	15.8 cm <sup>2</sup>
Chipset & other ICs quantity	5
Storage	
HDD quantity	1
HDD form factor	2.5
HDD IC area total	N/A
HDD IC quantity	N/A
Daughterboards	
Sub card total PWB area	863.9 cm <sup>2</sup>
Sub card main chip package area	0.0 cm <sup>2</sup>
Sub card chip count	1
PSU	
PSU weight	0.89 kg
PSU dimensions	19.4 x 8.0 cm
Optical disk drives	
ODD quantity	1
Use <sup>4</sup>	
Product lifetime	5 years
Yearly energy consumption	1051 kWh
Location	
Assembly location	United States
Use location	Europe
Transportation	
To country of use by air	6120 km
Within country of use by truck	300 km
End of life	
Fraction recycled	0.97
Fraction shredded recycling	0.00

**Table 8:** PAIA input information for the IBM z16<sup>™</sup> rack mount Support Element

The data used in the PAIA network tool is provided in Table 9 for the IBM z16<sup>™</sup> rack mount 24-port Ethernet Switch.

PAIA input information <sup>6</sup>	
Form factor	Rack
Product weight	3.3 kg
Packaging weight	N/A
Chassis weight	2.6 kg
Number of switches	1
Rack weight	N/A
Motherboard	
PWB area	0.061 m <sup>2</sup>
CPU quantity	1
CPU package area	7.3 cm <sup>2</sup>
DRAM total capacity	1 GB
Chipset & other ICs count	4
Chipset & other ICs area	2.9 cm <sup>2</sup>
Sub boards	
Sub card total PWB area	0.01 m <sup>2</sup>
Sub card main chip package area	0.001 cm <sup>2</sup>
Sub card chip count	1
PSU	
PSU count	1
PSU weight	0.19 kg
PSU dimensions	12.7 x 7.6 cm
Fan Tray	
Fan count	1
Ports	
Port count	24
Use <sup>4</sup>	
Product lifetime	5 years
Yearly energy consumption	964 kWh
Location	
Use location	Europe
Transportation	
To country of use by air	6120 km
Within country of use by truck	300 km

 Table 9: PAIA input information for the IBM z16™ rack mount 24-port

 Ethernet Switch

#### Limitations of PAIA

PAIA results represent a streamlined Life Cycle Assessment (LCA). While the product carbon footprint provides a high-level estimate of the emissions associated with the product, it should not be used for emissions inventory, formal carbon foot printing exercises or comparing products. LCA results are strongly influenced by the assumptions made by the analyst; if those assumptions are inconsistent, comparisons are not likely meaningful. Furthermore, PAIA may not be compliant with the primary data requirements of some LCA standards. The results from the PAIA tools are liable to change over time as the methodology is improved and data is updated. More information on these limitations, as well as general guidance for interpreting this report, is available in the publication "Assessment of lifecycle carbon footprints of products"

#### Disclaimers

 $^{1}$  The results are reported using the units of kilograms of carbon dioxide equivalent (kg CO<sub>2</sub>e). This represents the amount of global warming caused by a quantity of GHGs (CO<sub>2</sub>, CH<sub>4</sub>, N<sub>2</sub>O, HFCs, PFCs and SFe) at a specific point in time, expressed in terms of the amount of CO<sub>2</sub> which would have the same instantaneous warming effect. Recognizing the uncertainty in carbon footprint estimates, the results have been rounded to the nearest thousand.

 $^2$  The electricity consumption is incurred by clients using an IBM product. The estimate used is not specific to any client deployment of the IBM product or client workload.

<sup>3</sup> The estimated carbon footprint was computed including the shipping crate.

<sup>4</sup> Power consumption data is obtained using the IBM Power Estimation Tool for the IBM 216<sup>™</sup> rack mount, a web-based tool for estimating power requirements for the IBM 216<sup>™</sup> rack mount. This tool estimates the typical power requirements for the specific configuration listed in Table 1 under Normal operating conditions. The power consumption assumes that the product operates 24 hours a day, 365 days a year for its product lifetime.

 $^5$  The estimated carbon footprint was computed including the shipping crate. The carbon footprint without the shipping crate for the IBM z16<sup> m marcolore</sup> rack mount Support Element is 3,000 ± 2,000 kg CO<sub>2</sub>e.

<sup>6</sup> The estimated carbon footprint was computed without the shipping crate. The estimated carbon footprint of the shipping crate is included in the carbon footprint report for the IBM z16<sup>™</sup> rack mount Support Element.

© Copyright 2023 IBM Corporation 1 Orchard Road Armonk, NY 10504

Produced in the United States of America, April 4, 2023

IBM, the IBM logo, ibm.com are trademarks of International Business Machines Corp., registered in many jurisdictions worldwide. Other product and service names might be trademarks of IBM or other companies.

A current list of IBM trademarks is available on the web at "Copyright and trademark information" at <u>ibm.com/legal/copytrades.html</u>

The registered trademark Linux is used pursuant to a sublicense from the Linux Foundation, the exclusive licensee of Linus Torvalds, owner of the mark on a world¬wide basis.

This document is current as of the initial date of publication and may be changed by IBM at any time. Not all offerings are available in every country in which IBM operates.

The performance data discussed herein is presented as derived under specific operating conditions. Actual results may vary.

THE INFORMATION IN THE DOCUMENT IS PROVIDED "AS IS" WITHOUT ANY WARRANTY, EXPRESS OR IMPLIED, INCLUDING WITHOUT ANY WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE AND ANY WARRANTY OR CONDITION ON NON-INFRINGEMENT. IBM products are warranted according to the terms and conditions of the agreements under which they are provided.